

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 6,795,166 B2
DATED : September 21, 2004
INVENTOR(S) : Hideo Kato et al.

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Title page.

Item [*] Notice, the following paragraph should be inserted:

-- This patent issued on a continued prosecution application filed under 37 CFR 1.53(d), and is subject to the twenty year patent term provisions of 35 U.S.C. 154(a)(2). --

Column 1.

Line 21 "to high integration" should read -- to the use of --.

Line 22, "ricating" should read -- ricating high-integration --.

Line 23, "used" should read -- used, --.

Line 26, "Substance" should read -- Substances --.

Column 2.

Line 6, "system;" should read -- system. --.

Line 13, "illuminated; and" should read -- illuminated. --.

Line 23, the right margin should be closed up.

Line 24, the left margin should be closed up.

Line 50, "apparatus;" should read -- apparatus. --.

Line 57, "substrate;" should read -- substrate. --.

Column 3.

Line 2, the right margin should be closed up.

Line 3, the left margin should be closed up.

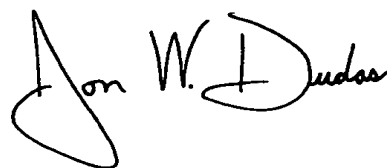
Line 35, "aligner;" should read -- aligner. --.

Line 43, "wafer; and" should read -- wafer. --.

Line 55, the right margin should be closed up.

Signed and Sealed this

Eleventh Day of January, 2005



JON W. DUDAS
Director of the United States Patent and Trademark Office